

## N-Channel Trench Power MOSFET

### General Description

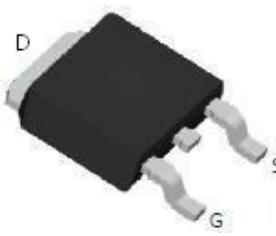
The HD80N06 combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ . Those devices are suitable for use in PWM, load switching and general purpose applications.

### Features

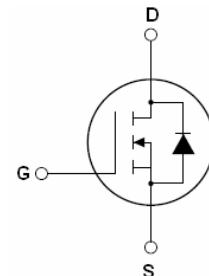
- $V_{DS}=60V$ ;  $I_D=80A$   
 $R_{DS(ON)}<11m\Omega$  @  $V_{GS}=10V$
- Ultra Low On-Resistance
- High UIS and UIS 100% Test

### Application

- Power switching application
- Load switching



To-252 Top View



Schematic Diagram

$V_{DS}=60V$

$I_D = 80A$

$R_{DS(ON)} = 9m\Omega$

### Package Marking and Ordering Information

| Device Marking | Device  | Device Package | Reel Size | Tape width | Quantity |
|----------------|---------|----------------|-----------|------------|----------|
| HD80N06        | HD80N06 | TO-252         | -         | -          | -        |

**Table 1. Absolute Maximum Ratings (TA=25°C)**

| Symbol           | Parameter  | Value      | Unit |
|------------------|--|------------|------|
| $V_{DS}$         | Drain-Source Voltage ( $V_{GS}=0V$ )                         | 60         | V    |
| $V_{GS}$         | Gate-Source Voltage ( $V_{DS}=0V$ )                          | $\pm 25$   | V    |
| $I_D$ (DC)       | Drain Current (DC) at $T_c=25^\circ C$                       | 80         | A    |
| $I_D$ (DC)       | Drain Current (DC) at $T_c=100^\circ C$                      | 56         | A    |
| $I_{DM}$ (pulse) | Drain Current-Continuous@ Current-Pulsed <sup>(Note 1)</sup> | 280        | A    |
| $P_D$            | Maximum Power Dissipation( $T_c=25^\circ C$ )                | 160        | W    |
| $E_{AS}$         | Single Pulse Avalanche Energy <sup>(Note 2)</sup>            | 480        | mJ   |
| $T_J, T_{STG}$   | Operating Junction and Storage Temperature Range             | -55 To 175 | °C   |

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2.EAS condition: $T_J=25^\circ C, V_{DD}=30V, V_G=10V, R_G=25\Omega$

**Table 2. Thermal Characteristic**

| Symbol          | Parameter                            | Value | Max  | Unit |
|-----------------|--------------------------------------|-------|------|------|
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case | ---   | 0.85 | °C/W |

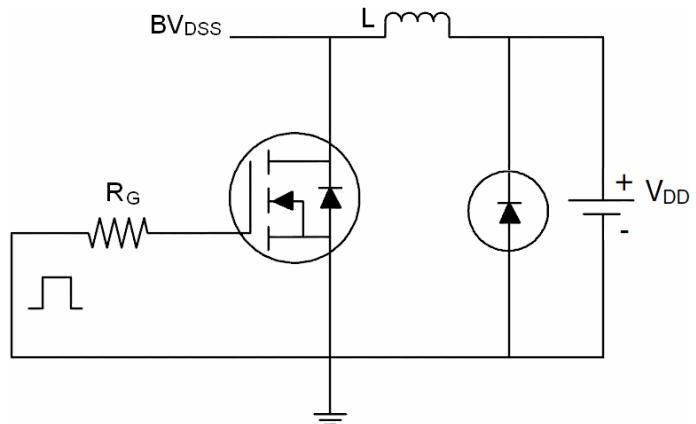
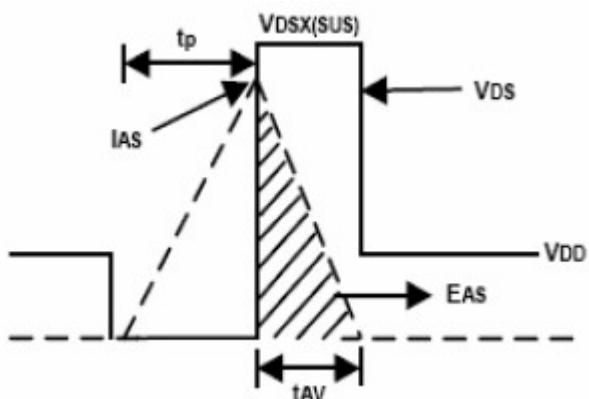
**Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)**

| Symbol                                    | Parameter  | Conditions   | Min | Typ  | Max       | Unit      |
|---|--|--|-----|------|-----------|-----------|
| <b>On/Off States</b>                      |  |  |     |      |           |           |
| $BV_{DSS}$                                | Drain-Source Breakdown Voltage                       | $V_{GS}=0V, I_D=250\mu A$  | 60  | 70   |           | V         |
| $I_{DSS}$                                 | Zero Gate Voltage Drain Current( $T_c=25^\circ C$ )  | $V_{DS}=60V, V_{GS}=0V$  |     |      | 1         | $\mu A$   |
| $I_{DSR}$                                 | Zero Gate Voltage Drain Current( $T_c=100^\circ C$ ) | $V_{DS}=60V, V_{GS}=0V$  |     |      | 5         | $\mu A$   |
| $I_{GSS}$                                 | Gate-Body Leakage Current                            | $V_{GS}=\pm 25V, V_{DS}=0V$  |     |      | $\pm 100$ | nA        |
| $V_{GS(th)}$                              | Gate Threshold Voltage                               | $V_{DS}=V_{GS}, I_D=250\mu A$  | 2   | 3    | 4         | V         |
| $R_{DS(on)}$                              | Drain-Source On-State Resistance                     | $V_{GS}=10V, I_D=40A$  |     | 9    | 11        | $m\Omega$ |
| <b>Dynamic Characteristics</b>            |  |  |     |      |           |           |
| $g_{FS}$                                  | Forward Transconductance                             | $V_{DS}=10V, I_D=40A$  | 18  |      |           | S         |
| $C_{iss}$                                 | Input Capacitance                                    | $V_{DS}=25V, V_{GS}=0V$<br>$f=1.0MHz$                                    |     | 2450 |           | PF        |
| $C_{oss}$                                 | Output Capacitance                                   |  |     | 910  |           | PF        |
| $C_{rss}$                                 | Reverse Transfer Capacitance                         |  |     | 145  |           | PF        |
| $Q_g$                                     | Total Gate Charge                                    | $V_{DS}=30V, I_D=40A$<br>$V_{GS}=10V$                                    |     | 57   |           | nC        |
| $Q_{gs}$                                  | Gate-Source Charge                                   |  |     | 15   |           | nC        |
| $Q_{gd}$                                  | Gate-Drain Charge                                    |  |     | 24   |           | nC        |
| <b>Switching Times</b>                    |  |  |     |      |           |           |
| $t_{d(on)}$                               | Turn-on Delay Time                                   | $V_{DS}=30V, R_L=2.5\Omega$<br>$V_{GS}=10V, R_G=3\Omega$                 |     | 32   |           | nS        |
| $t_r$                                     | Turn-on Rise Time                                    |  |     | 240  |           | nS        |
| $t_{d(off)}$                              | Turn-Off Delay Time                                  |  |     | 120  |           | nS        |
| $t_f$                                     | Turn-Off Fall Time                                   |  |     | 96   |           | nS        |
| <b>Source-Drain Diode Characteristics</b> |  |  |     |      |           |           |
| $I_{SD}$                                  | Source-Drain Current(Body Diode)                     |  |     | 50   |           | A         |
| $I_{SDM}$                                 | Pulsed Source-Drain Current(Body Diode)              |  |     | 200  |           | A         |
| $V_{SD}$                                  | Forward On Voltage <sup>(Note 1)</sup>               | $T_J=25^\circ C, I_{SD}=1A, V_{GS}=0V$                                   |     | 1.2  | 1.4       | V         |
| $t_{rr}$                                  | Reverse Recovery Time <sup>(Note 1)</sup>            | $T_J=25^\circ C, I_F=40A$<br>$di/dt=100A/\mu s$                          |     | 64   |           | nS        |
| $Q_{rr}$                                  | Reverse Recovery Charge <sup>(Note 1)</sup>          |  |     | 120  |           | nC        |
| $t_{on}$                                  | Forward Turn-on Time                                 | Intrinsic turn-on time is negligible(turn-on is dominated by $L_S+L_D$ ) |     |      |           |           |

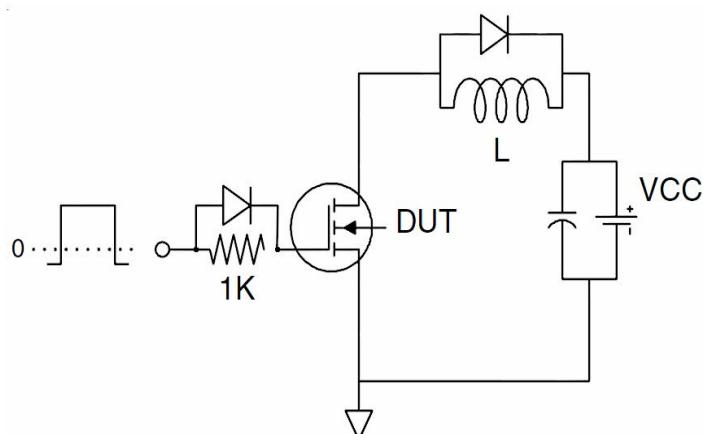
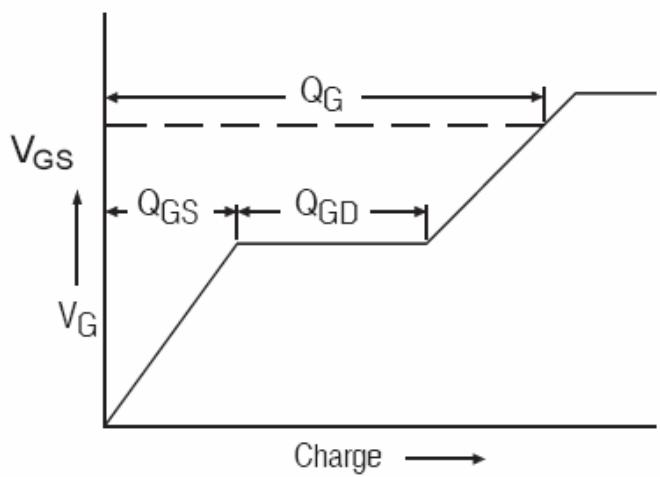
Notes 1.Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 1.5\%$ , Starting  $T_J=25^\circ C$

## Test Circuit

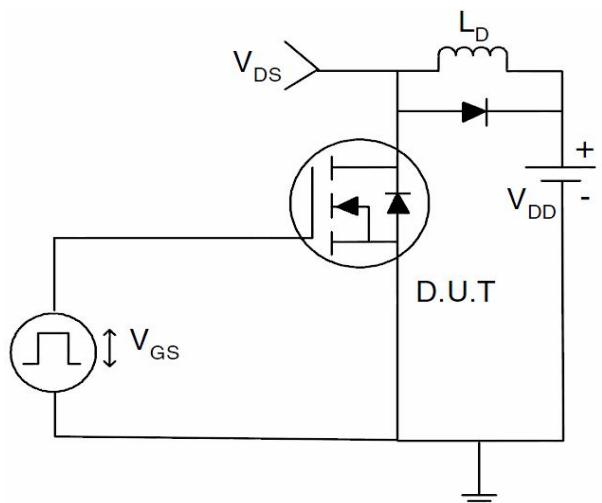
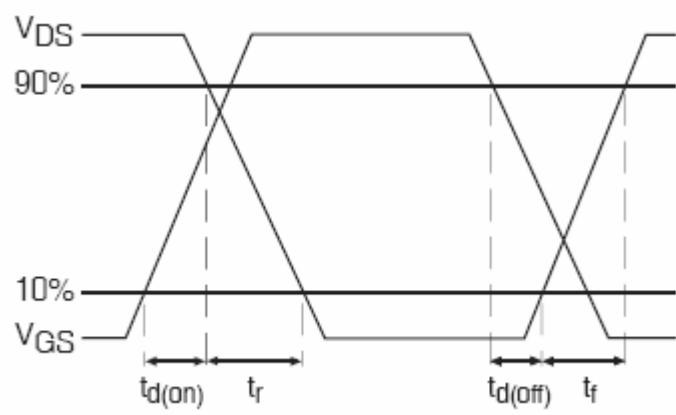
### 1) E<sub>AS</sub> Test Circuits

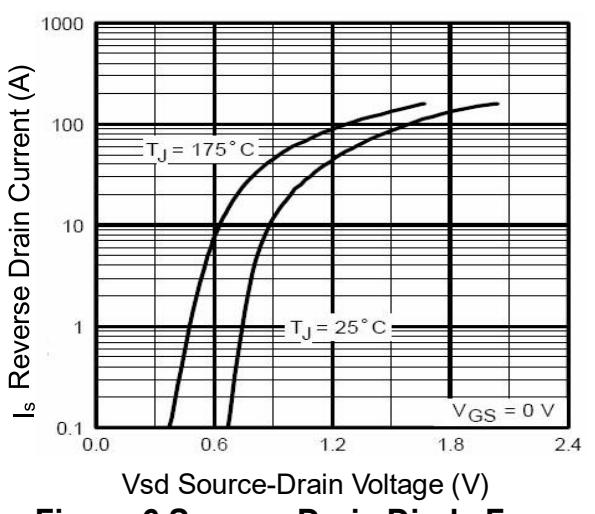
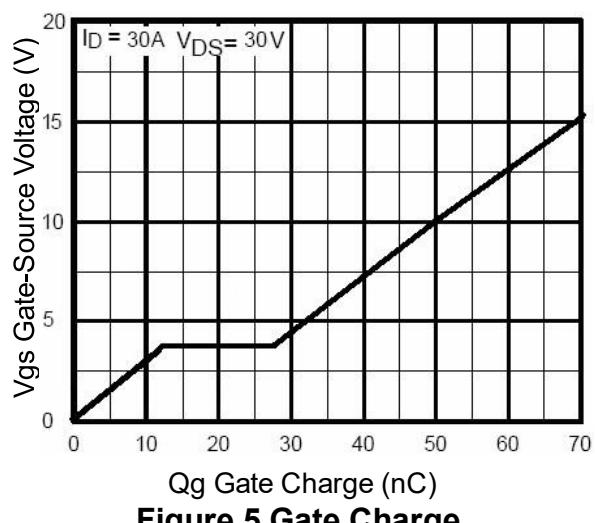
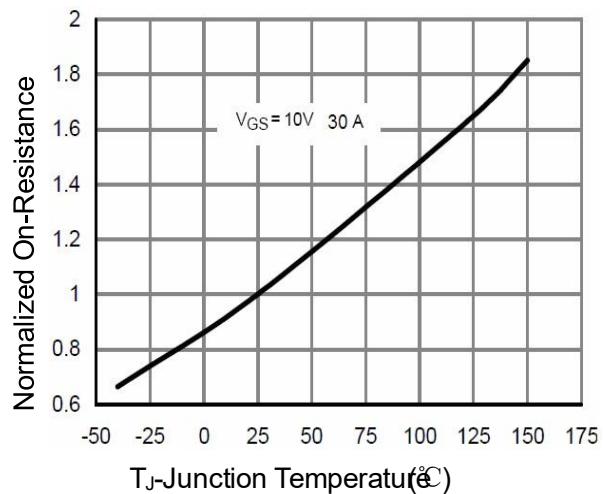
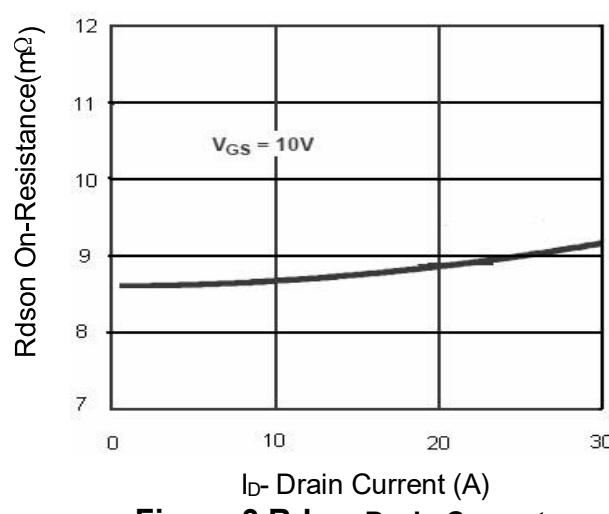
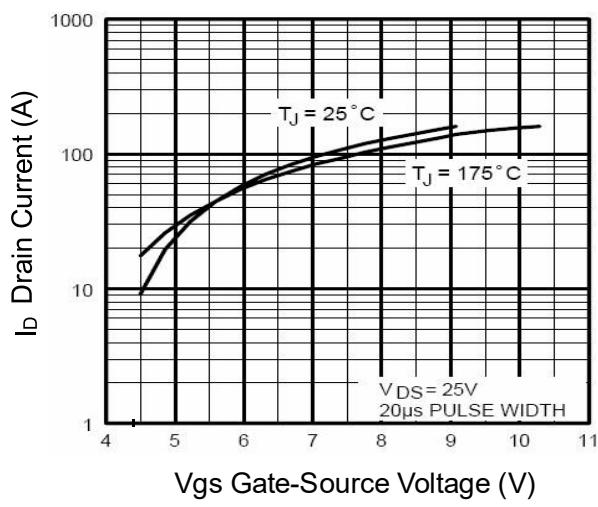
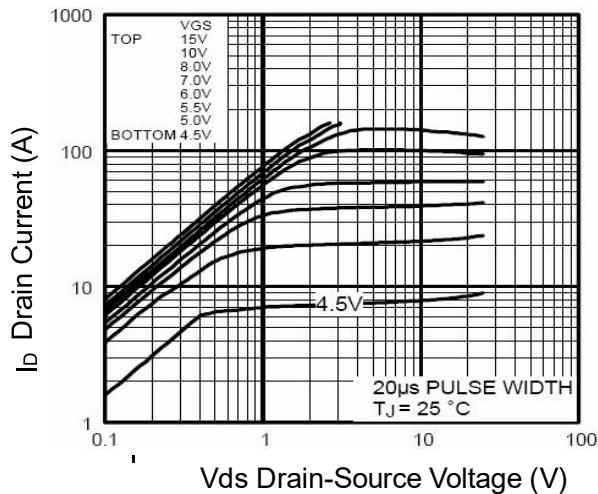


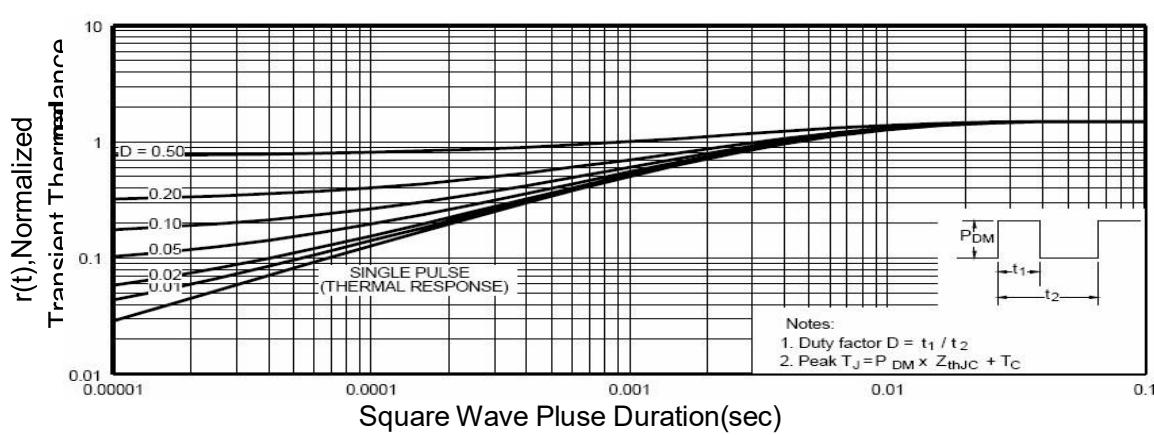
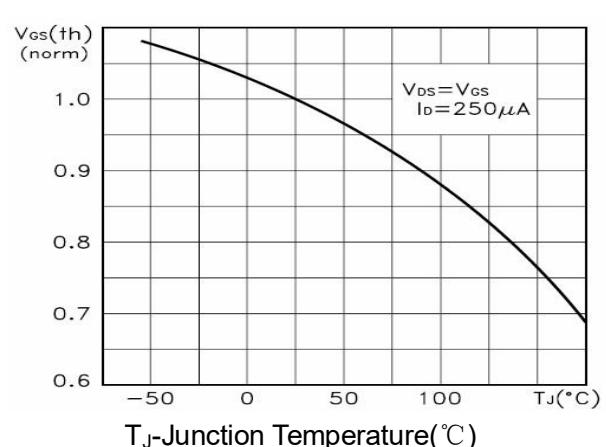
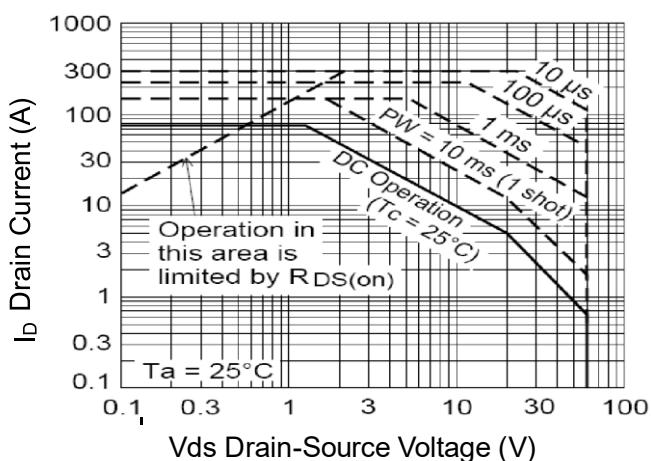
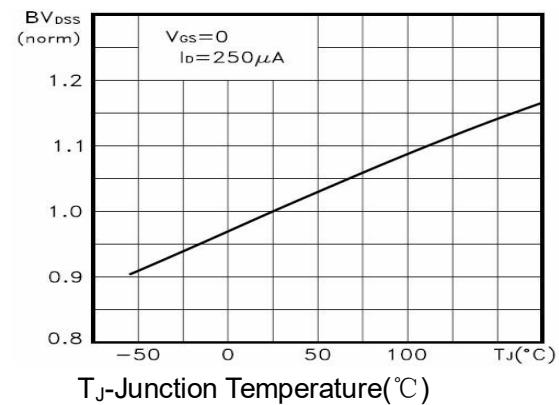
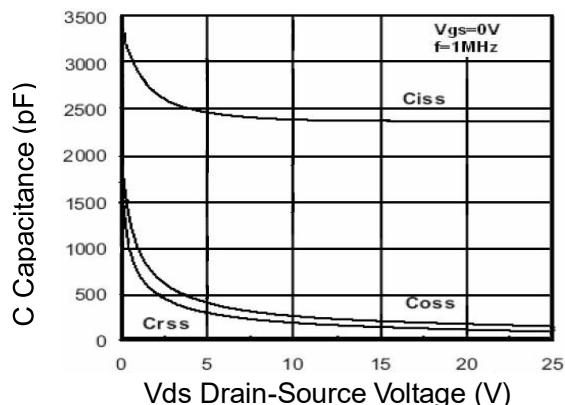
### 2) Gate Charge Test Circuit:



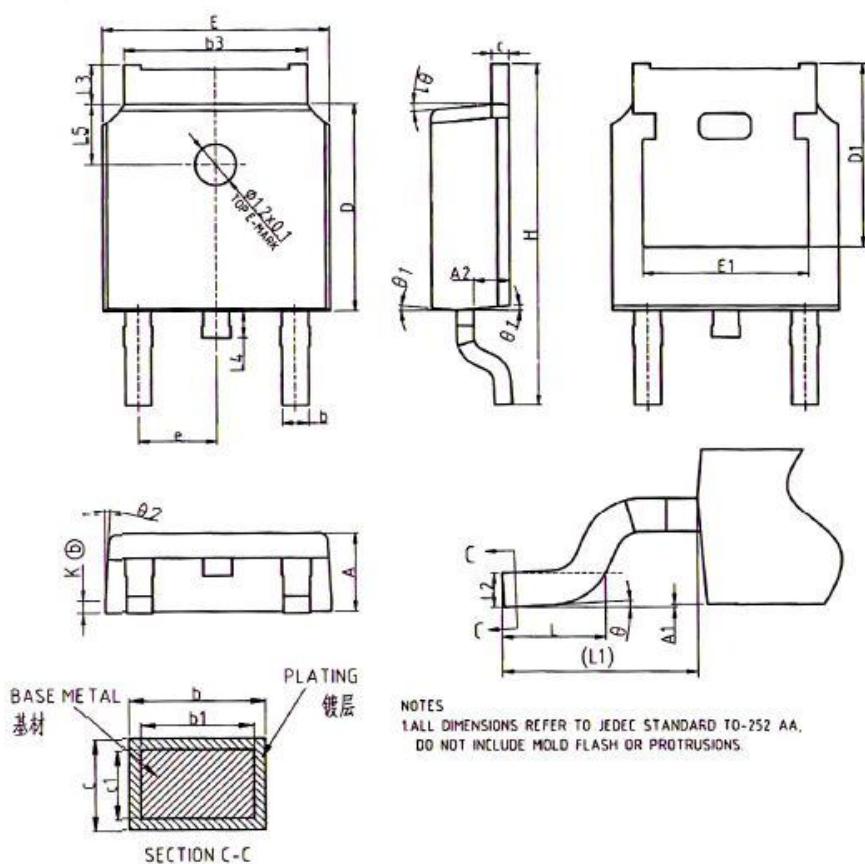
### 3) Switch Time Test Circuit:



**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (Curves)**




## TO-252 Package Information



| SYMBOL | COMMON DIMENSIONS |          |       |
|--------|-------------------|----------|-------|
|        | MIN               | NOM      | MAX   |
| A      | 2.20              | 2.30     | 2.38  |
| A1     | 0.00              | -        | 0.10  |
| A2     | 0.97              | 1.07     | 1.17  |
| b      | 0.72              | 0.78     | 0.85  |
| b1     | 0.71              | 0.76     | 0.81  |
| b3     | 5.23              | 5.33     | 5.46  |
| c      | 0.47              | 0.53     | 0.58  |
| c1     | 0.46              | 0.51     | 0.56  |
| D      | 6.00              | 6.10     | 6.20  |
| D1     |                   | 5.30REF  |       |
| E      | 6.50              | 6.60     | 6.70  |
| E1     | 4.70              | 4.83     | 4.92  |
| e      |                   | 2.286BSC |       |
| H      | 9.90              | 10.10    | 10.30 |
| L      | 1.40              | 1.50     | 1.70  |
| L1     |                   | 2.90REF  |       |
| L2     |                   | 0.51BSC  |       |
| L3     | 0.90              | -        | 1.25  |
| L4     | 0.60              | 0.80     | 1.00  |
| L5     | 1.70              | 1.80     | 1.90  |
| θ      | 0°                | -        | 8°    |
| θ1     | 5°                | 7°       | 9°    |
| θ2     | 5°                | 7°       | 9°    |
| K      |                   | 0.10REF  |       |

NOTES  
1. ALL DIMENSIONS REFER TO JEDEC STANDARD TO-252 AA.  
DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.

# X-ON Electronics

Largest Supplier of Electrical and Electronic Components

*Click to view similar products for MOSFET category:*

*Click to view products by Haolin manufacturer:*

Other Similar products are found below :

[IRFD120](#) [IRFY240C](#) [JANTX2N5237](#) [BUK455-60A/B](#) [MIC4420CM-TR](#) [VN1206L](#) [NDP4060](#) [SI4482DY](#) [IPS70R2K0CEAKMA1](#)  
[SQD23N06-31L-GE3](#) [TK16J60W,S1VQ\(O](#) [2SK2614\(TE16L1,Q\)](#) [DMN1017UCP3-7](#) [EFC2J004NUZTDG](#) [DMN1053UCP4-7](#) [SQJ469EP-T1-GE3](#) [NTE2384](#) [DMC2700UDMQ-7](#) [DMN2080UCB4-7](#) [DMN61D9UWQ-13](#) [US6M2GTR](#) [DMN31D5UDJ-7](#) [DMP22D4UFO-7B](#)  
[DMN1006UCA6-7](#) [DMN16M9UCA6-7](#) [STF5N65M6](#) [IRF40H233XTMA1](#) [STU5N65M6](#) [DMN6022SSD-13](#) [DMN13M9UCA6-7](#)  
[DMTH10H4M6SPS-13](#) [DMN2990UFB-7B](#) [IPB80P04P405ATMA2](#) [2N7002W-G](#) [MCAC30N06Y-TP](#) [MCQ7328-TP](#) [NTMC083NP10M5L](#)  
[NVMFS2D3P04M8LT1G](#) [BXP7N65D](#) [BXP4N65F](#) [AOL1454G](#) [WMJ80N60C4](#) [BXP2N20L](#) [BXP2N65D](#) [BXT1150N10J](#) [BXT1700P06M](#)  
[TSM60NB380CP ROG](#) [RQ7L055BGTCR](#) [DMNH15H110SK3-13](#) [SLF10N65ABV2](#)